



Serial No. 09/647,743

1998/G 004 (5587~264)

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE AS FIRST-CLASS MAIL IN AN ENVELOPE ADDRESSED TO: ASSISTANT COMMISSIONER FOR PATENTS, WASHINGTON DC 20231

ON THIS 3rd DAY OF

your Ferry

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

STEFAN DISCH ET AL

SERIAL NO: 09/647,743 : ART UNIT: 1714

FILED: OCTOBER 4, 2000 : EXAMINER: SZEKELY, P. A.

FOR: POLYOXYMETHYLENE MOULDING

MATERIAL WITH IMPROVED PROCESSING STABILITY AND A REDUCED EMISSIONS TENDENCY

Assistant Commissioner for Patents Washington, DC 20231

Sir:

SUPPLEMENTAL AMENDMENT

In response to the outstanding Office Action dated August 20, 2002, kindly amend the above-identified application as follows.

IN THE CLAIMS

Please cancel claim 14.

Please add the following new claims:

--15. A low-emission molding having the formaldehyde emission of less than 15 mg/kg, measured on sheets of wall thickness 1 mm after 24 hours in accordance with VDA 275, while retaining a modulus of elasticity in accordance with ISO 527 of from 2400 to 3100 N/mm2, a yield stress in accordance with ISO 527 of from

